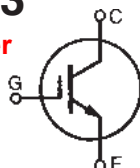


GenX3™ 300V IGBT IXGA42N30C3

IXGH42N30C3*

IXGP42N30C3

*Obsolete Part Number

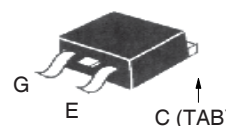


High Speed PT IGBTs for
50-150kHz switching

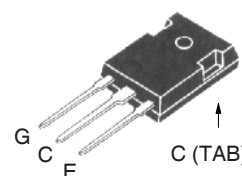
$V_{CES} = 300V$
 $I_{C110} = 42A$
 $V_{CE(sat)} \leq 1.85V$
 $t_{fi\ typ} = 65ns$

| Symbol | Test Conditions | Maximum Ratings | |
|-------------------------------|--|-----------------|------------|
| V_{CES} | $T_J = 25^\circ C$ to $150^\circ C$ | 300 | V |
| V_{CGR} | $T_J = 25^\circ C$ to $150^\circ C$, $R_{GE} = 1M\Omega$ | 300 | V |
| V_{GES} | Continuous | ± 20 | V |
| V_{GEM} | Transient | ± 30 | V |
| I_{C110} | $T_C = 110^\circ C$ (chip capability) | 42 | A |
| I_{CM} | $T_C = 25^\circ C$, 1ms | 250 | A |
| I_A | $T_C = 25^\circ C$ | 42 | A |
| E_{AS} | $T_C = 25^\circ C$ | 250 | mJ |
| SSOA (RBSOA) | $V_{GE} = 15V$, $T_{VJ} = 125^\circ C$, $R_G = 10\Omega$ Clamped inductive load @ $\leq 300V$ | $I_{CM} = 84$ | A |
| P_C | $T_C = 25^\circ C$ | 223 | W |
| T_J | | -55 ... +150 | $^\circ C$ |
| T_{JM} | | 150 | $^\circ C$ |
| T_{stg} | | -55 ... +150 | $^\circ C$ |
| T_L | Maximum lead temperature for soldering | 300 | $^\circ C$ |
| T_{SOLD} | 1.6mm (0.062 in.) from case for 10s | 260 | $^\circ C$ |
| M_d | Mounting torque (TO-247)(TO-220) | 1.13/10 | Nm/lb.in. |
| Weight | TO-263 | 2.5 | g |
| | TO-247 | 6.0 | g |
| | TO-220 | 3.0 | g |

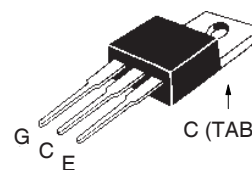
TO-263 (IXGA)



TO-247 (IXGH)



TO-220 (IXGP)



G = Gate C = Collector
 E = Emitter TAB = Collector

Features

- Optimized for low switching losses
- Square RBSOA
- High current handling capability
- International standard packages

Advantages

- High power density
- Low gate drive requirement

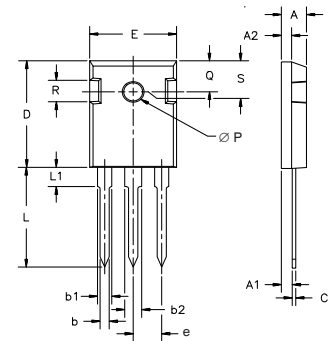
Applications

- High Frequency Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts

| Symbol | Test Conditions ($T_J = 25^\circ C$, unless otherwise specified) | Characteristic Values | | |
|---------------|---|-----------------------|------|--------------|
| | | Min. | Typ. | Max. |
| BV_{CES} | $I_C = 250\mu A$, $V_{GE} = 0V$ | 300 | | V |
| $V_{GE(th)}$ | $I_C = 250\mu A$, $V_{CE} = V_{GE}$ | 2.5 | | 5.0 V |
| I_{CES} | $V_{CE} = V_{CES}$ | | | 25 μA |
| | $V_{GE} = 0V$ $T_J = 125^\circ C$ | | | 500 μA |
| I_{GES} | $V_{CE} = 0V$, $V_{GE} = \pm 20V$ | | | ± 100 nA |
| $V_{CE(sat)}$ | $I_C = 42A$, $V_{GE} = 15V$, Note1 | | 1.54 | 1.85 V |
| | $T_J = 125^\circ C$ | | 1.54 | V |

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, unless otherwise specified) | Characteristic Values | | |
|--------------|--|-----------------------|---------|--------------------|
| | | Min. | Typ. | Max. |
| g_{fs} | $I_C = 0.5 \cdot I_{C110}, V_{CE} = 10\text{V}$, Note 1 | 20 | 33 | S |
| C_{ies} | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$ | | 2140 | pF |
| C_{oes} | | | 218 | pF |
| C_{res} | | | 60 | pF |
| Q_g | $I_C = I_{C110}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$ | | 76 | nC |
| Q_{ge} | | | 15 | nC |
| Q_{gc} | | | 26 | nC |
| $t_{d(on)}$ | Inductive Load, $T_J = 25^\circ\text{C}$ $I_C = 0.5 \cdot I_{C110}, V_{GE} = 15\text{V}$ $V_{CE} = 200\text{V}, R_G = 10\Omega$ | | 21 | ns |
| t_{ri} | | | 23 | ns |
| E_{on} | | | 0.12 | mJ |
| $t_{d(off)}$ | | | 113 | 170 ns |
| t_{fi} | | | 65 | 120 ns |
| E_{off} | | 0.15 | 0.28 mJ | |
| $t_{d(on)}$ | Inductive Load, $T_J = 125^\circ\text{C}$ $I_C = 0.5 \cdot I_{C110}, V_{GE} = 15\text{V}$ $V_{CE} = 200\text{V}, R_G = 10\Omega$ | | 21 | ns |
| t_{ri} | | | 22 | ns |
| E_{on} | | | 0.21 | mJ |
| $t_{d(off)}$ | | | 127 | ns |
| t_{fi} | | | 102 | ns |
| E_{off} | | 0.20 | mJ | |
| R_{thJC} | | | 0.56 | $^\circ\text{C/W}$ |
| R_{thCK} | TO-220 | 0.50 | | $^\circ\text{C/W}$ |
| | TO-247 | 0.25 | | $^\circ\text{C/W}$ |

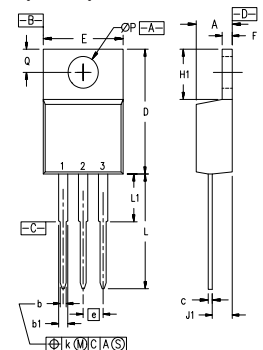
TO-247 AD Outline



| Dim. | Millimeter | | Inches | |
|----------------|------------|-------|--------|-------|
| | Min. | Max. | Min. | Max. |
| A | 4.7 | 5.3 | .185 | .209 |
| A ₁ | 2.2 | 2.54 | .087 | .102 |
| A ₂ | 2.2 | 2.6 | .059 | .098 |
| b | 1.0 | 1.4 | .040 | .055 |
| b ₁ | 1.65 | 2.13 | .065 | .084 |
| b ₂ | 2.87 | 3.12 | .113 | .123 |
| C | .4 | .8 | .016 | .031 |
| D | 20.80 | 21.46 | .819 | .845 |
| E | 15.75 | 16.26 | .610 | .640 |
| e | 5.20 | 5.72 | 0.205 | 0.225 |
| L | 19.81 | 20.32 | .780 | .800 |
| L1 | | 4.50 | | .177 |
| ∅P | 3.55 | 3.65 | .140 | .144 |
| Q | 5.89 | 6.40 | 0.232 | 0.252 |
| R | 4.32 | 5.49 | .170 | .216 |
| S | 6.15 | BSC | 242 | BSC |

Note1. Pulse test, $t \leq 300\mu\text{s}$; duty cycle, $d \leq 2\%$.

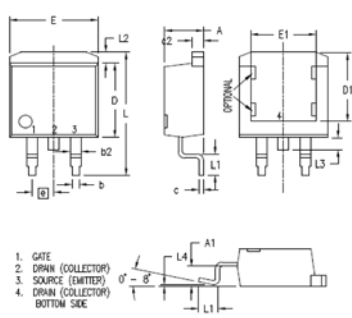
TO-220 (IXGP) Outline



Pins: 1 - Gate 2 - Drain

| SYM | INCHES | | MILLIMETERS | |
|-----|--------|------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .170 | .190 | 4.32 | 4.83 |
| b | .025 | .040 | 0.64 | 1.02 |
| b1 | .045 | .065 | 1.15 | 1.65 |
| c | .014 | .022 | 0.35 | 0.56 |
| D | .580 | .630 | 14.73 | 16.00 |
| E | .390 | .420 | 9.91 | 10.66 |
| e | .100 | BSC | 2.54 | BSC |
| F | .045 | .055 | 1.14 | 1.40 |
| H1 | .230 | .270 | 5.85 | 6.85 |
| J1 | .090 | .110 | 2.29 | 2.79 |
| k | 0 | .015 | 0 | 0.38 |
| L | .500 | .550 | 12.70 | 13.97 |
| L1 | .110 | .230 | 2.79 | 5.84 |
| ∅P | .139 | .161 | 3.53 | 4.08 |
| Q | .100 | .125 | 2.54 | 3.18 |

TO-263 (IXGA) Outline



| SYM | INCHES | | MILLIMETERS | |
|-----|--------|------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .160 | .190 | 4.06 | 4.83 |
| A1 | .080 | .110 | 2.03 | 2.79 |
| b | .020 | .039 | 0.51 | 0.99 |
| b2 | .045 | .055 | 1.14 | 1.40 |
| c | .016 | .029 | 0.40 | 0.74 |
| c2 | .045 | .055 | 1.14 | 1.40 |
| D | .340 | .380 | 8.64 | 9.65 |
| D1 | .315 | .350 | 8.00 | 8.89 |
| E | .380 | .410 | 9.65 | 10.41 |
| E1 | .245 | .320 | 6.22 | 8.13 |
| e | .100 | BSC | 2.54 | BSC |
| L | .575 | .625 | 14.61 | 15.88 |
| L1 | .090 | .110 | 2.29 | 2.79 |
| L2 | .040 | .055 | 1.02 | 1.40 |
| L3 | .050 | .070 | 1.27 | 1.78 |
| L4 | 0 | .005 | 0 | 0.13 |

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2
by one or more of the following U.S. patents: 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2
4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

Fig. 1. Output Characteristics
@ 25°C

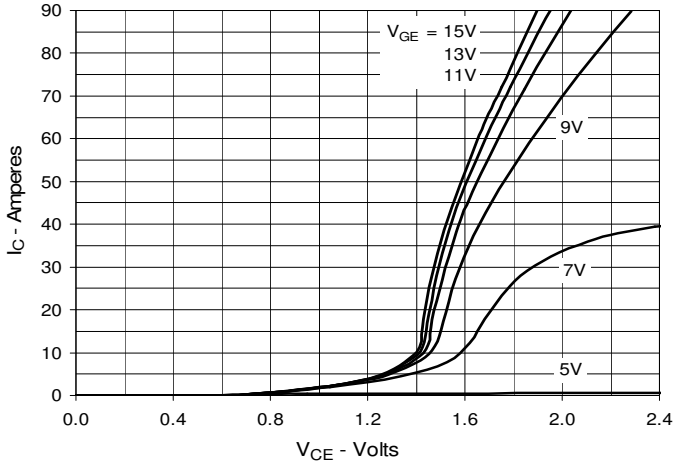


Fig. 2. Extended Output Characteristics
@ 25°C

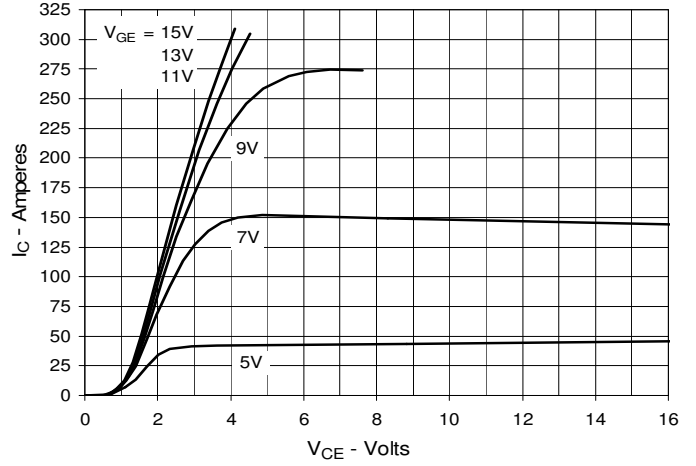


Fig. 3. Output Characteristics
@ 125°C

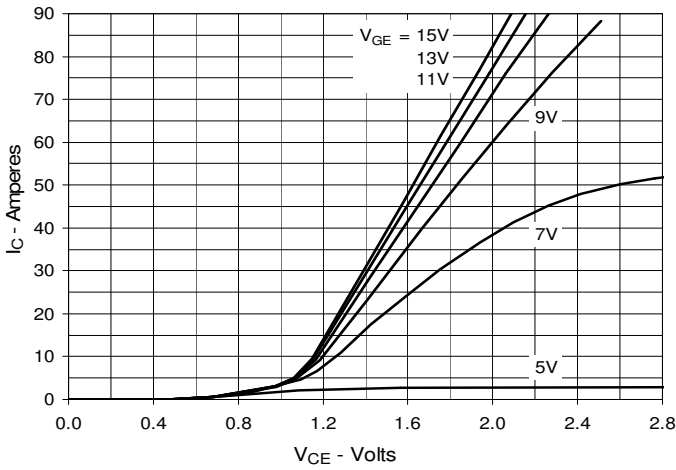


Fig. 4. Dependence of Vce(sat) on Junction Temperature

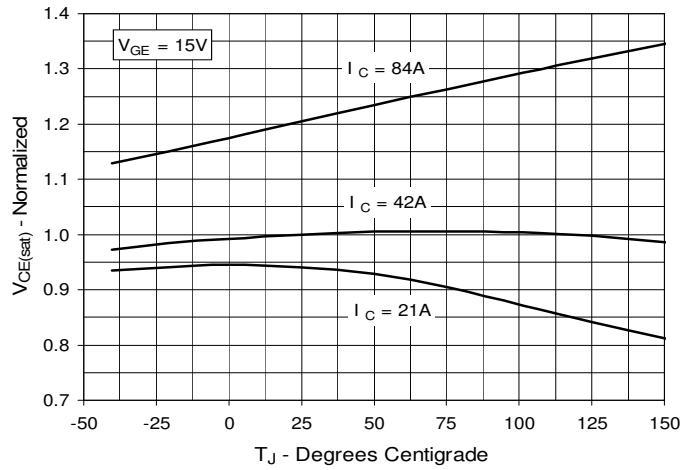


Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

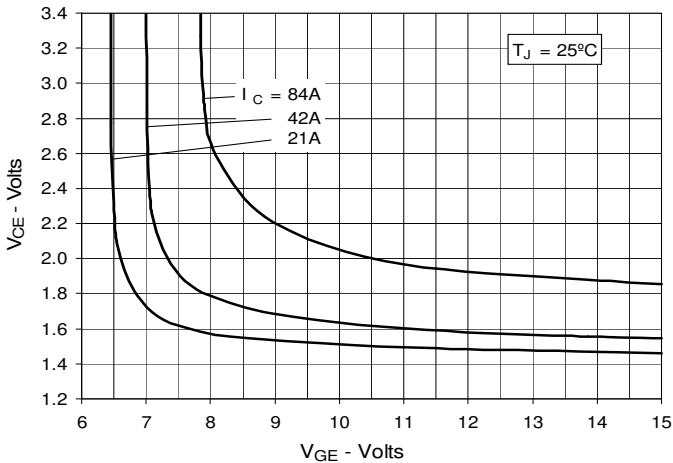


Fig. 6. Input Admittance

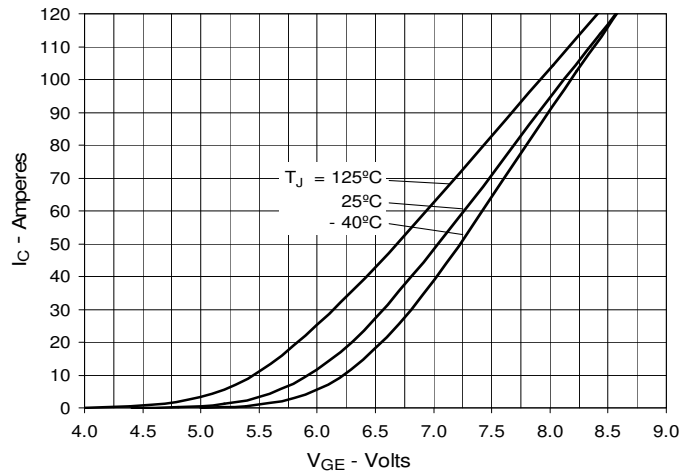


Fig. 7. Transconductance

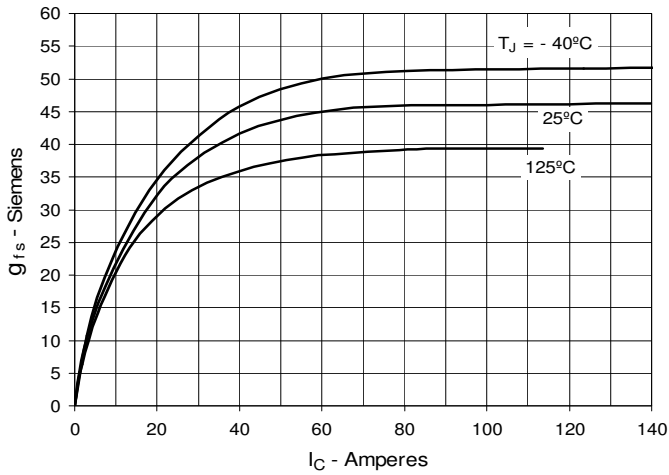


Fig. 8. Gate Charge

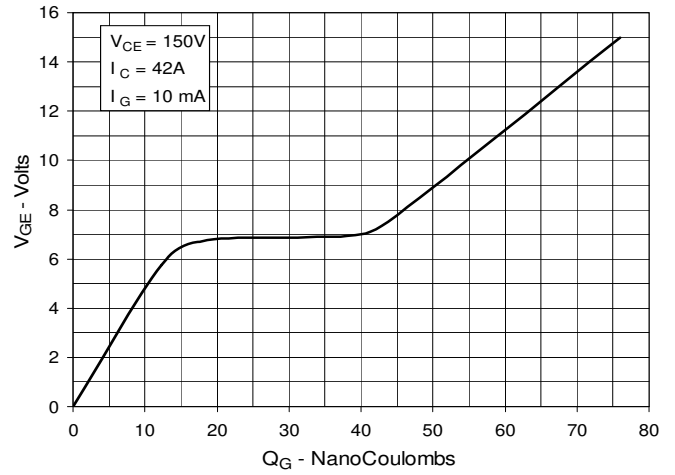


Fig. 9. Capacitance

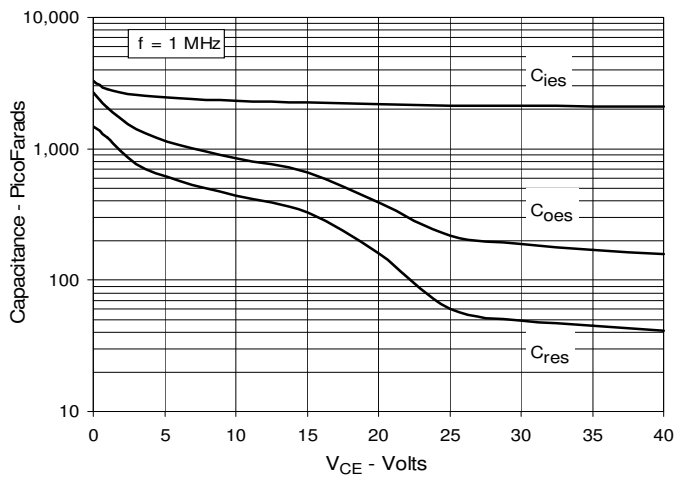


Fig. 10. Reverse-Bias Safe Operating Area

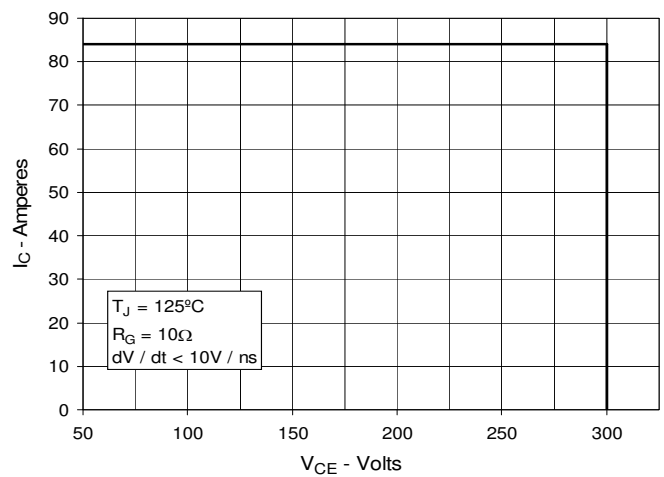


Fig. 11. Maximum Transient Thermal Impedance

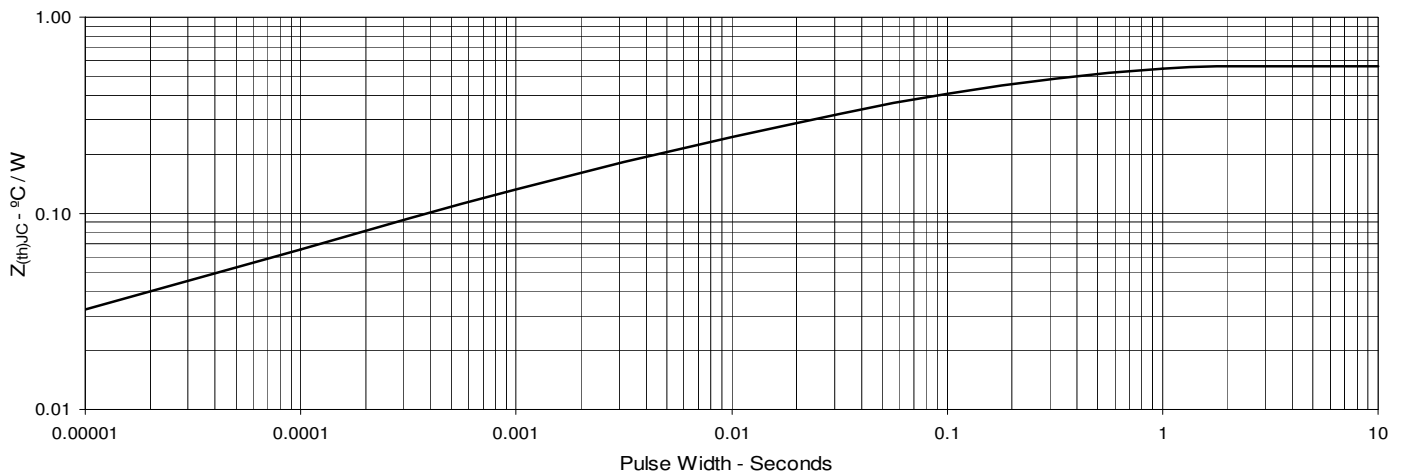


Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance

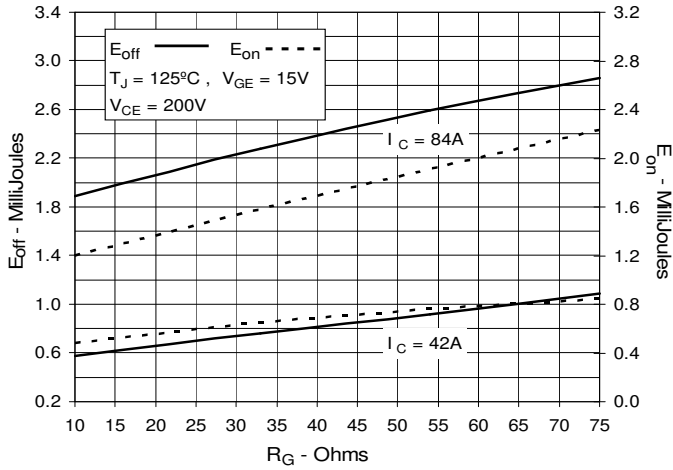


Fig. 13. Inductive Switching Energy Loss vs. Collector Current

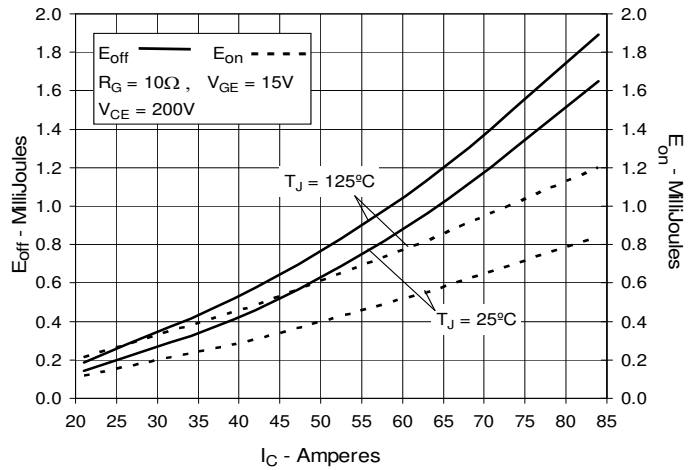


Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature

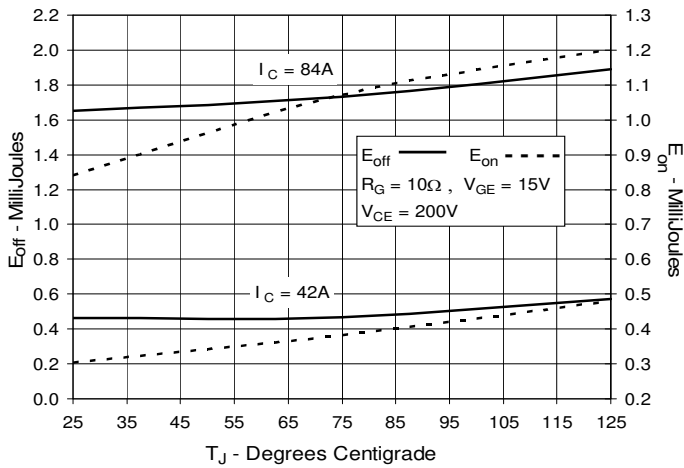


Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance

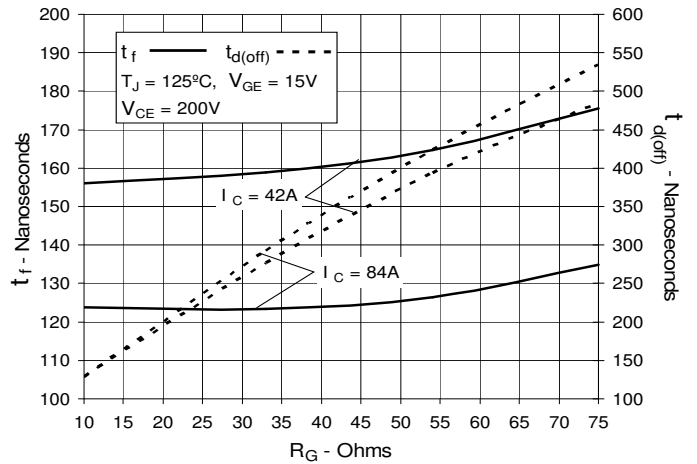


Fig. 16. Inductive Turn-off Switching Times vs. Collector Current

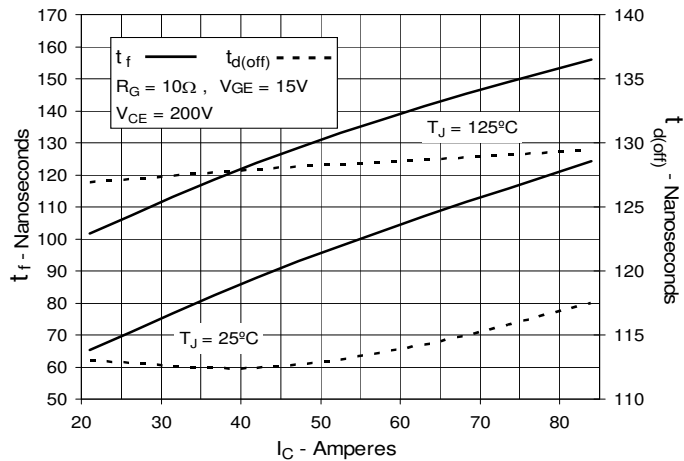


Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature

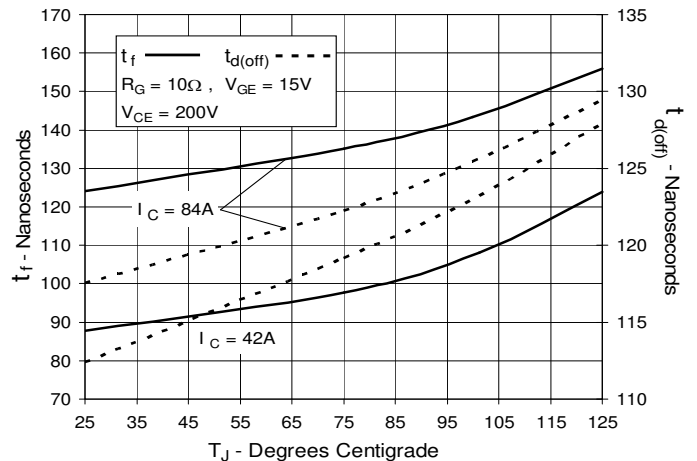


Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance

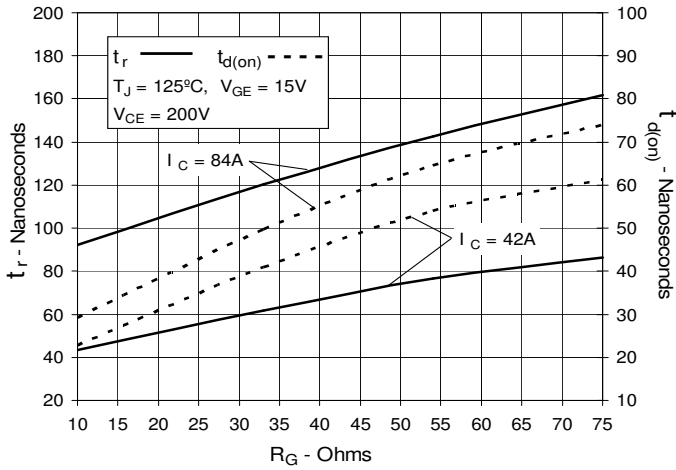


Fig. 19. Inductive Turn-on Switching Times vs. Collector Current

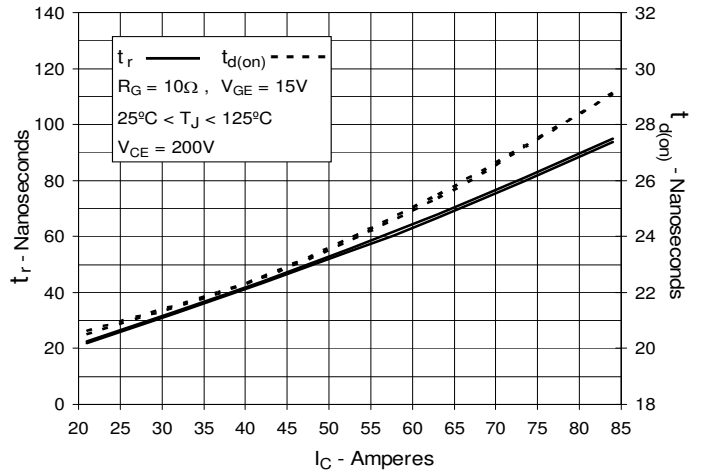
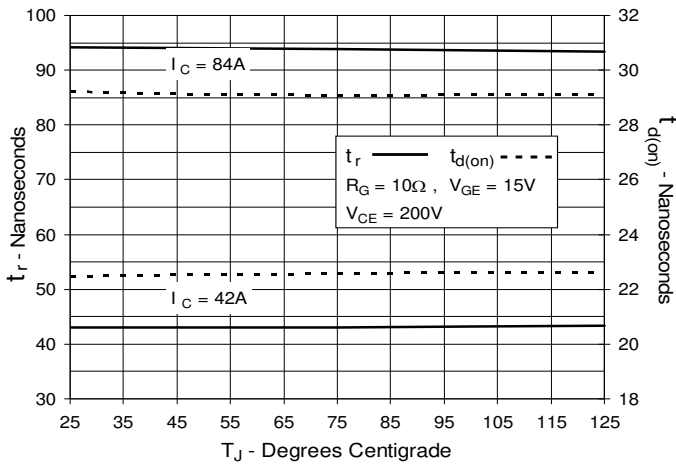


Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature





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